Vyncolit® TEM 9001

Epoxy; Epoxide Vyncolit N.V.

Message:

Vyncolit TEM 9001 is an epoxy. Epoxy resin material, containing filler glass fiber reinforced material. This product is available in North America, Africa and the Middle East, Latin America, Europe or Asia Pacific. The processing methods are: resin transfer molding, compression molding or injection molding. The main features of Vyncolit TEM 9001 are:

chemical resistance low viscosity Good toughness Heat resistance Typical application areas include: Electrical/electronic applications food contact applications

military applications

Specific Gravity

General Information				
Filler / Reinforcement	Glass fiber reinforced ma	erial		
Features	The degassing effect is lo	w to no		
	Low viscosity			
	Solvent resistance			
	Anti-salt water/fog			
	Good thermal shock resis	tance		
	Good chemical resistance			
	alkali resistance			
	acid resistance			
	Good toughness			
	Non-corrosive			
Uses	Electrical components			
	Military application			
	Connector			
Agency Ratings	FDA not rated			
	USDA Unspecified Appro-	/al		
Forms	Particles			
Processing Method	Resin transfer molding			
	Compression molding			
	Injection molding			
Physical	Nominal Value	Unit	Test Method	

g/cm³

ASTM D792

1.84

D.H.E.	2.1		ACTA D1005
Bulk Factor	2.1		ASTM D1895
Molding Shrinkage - Flow (Transfer Molded)	0.30	%	ASTM D955
Hardness	Nominal Value	Unit	Test Method
Rockwell Hardness (M-Scale)	115		ASTM D785
Mechanical	Nominal Value	Unit	Test Method
Tensile Strength	96.5	MPa	ASTM D638
Flexural Modulus	14800	MPa	ASTM D790
Flexural Strength	165	MPa	ASTM D790
Compressive Strength	255	MPa	ASTM D695
Impact	Nominal Value	Unit	Test Method
Notched Izod Impact	24	J/m	ASTM D256A
Thermal	Nominal Value	Unit	Test Method
Deflection Temperature Under Load (1.8 MPa, Unannealed)	160	°C	ASTM D648
CLTE - Flow	3.5E-5	cm/cm/°C	ASTM D696
Thermal Conductivity	0.63	W/m/K	ASTM C177
Electrical	Nominal Value	Unit	Test Method
Dielectric Strength			ASTM D149
1	16	kV/mm	ASTM D149
2	13	kV/mm	ASTM D149
Dielectric Constant (1 MHz)	4.50		ASTM D150
Dissipation Factor (1 MHz)	0.012		ASTM D150
Arc Resistance	180	sec	ASTM D495
Injection	Nominal Value	Unit	
Middle Temperature	60.0 - 82.2	°C	
Nozzle Temperature	82.2 - 93.3	°C	
Processing (Melt) Temp	93.3 - 116	°C	
Mold Temperature	149 - 177	°C	
Injection Pressure	34.5 - 68.9	MPa	
Holding Pressure	13.8 - 34.5	MPa	
Back Pressure	0.345	MPa	
Injection instructions			

Gauge: 0.3The value listed as Thermal Conductivity, ASTM C177, was tested in accordance with ASTM F433.Water Absorption, ASTM D570, 48 hrs, 50°C: 0.2%Dielectric Strength, ASTM D149, 60 Hz, Method A, wet: 400 V/milDielectric Strength, ASTM D149, 60 Hz, Method A, dry: 420 V/milDielectric Strength, ASTM D149, 60 Hz, Method B, dry: 350 V/milDielectric Constant, ASTM D150, 1000000 Hz, dry: 4.5Dissipation Factor, ASTM D150, 1000000 Hz, dry: 0.012Bulk Factor, ASTM D1895: 2 to 2.2Compression and Transfer Molding Conditions:

Preheat Temperature: 180 to 225 °F Mold Temperature: 325 to 370 °F

Compression Mold Pressure: 1000 to 5000 psi Transfer Mold Pressure: 1500 to 8000 psi Cure Time, 0.125 in: 60 to 90 sec

NOTE	
1.	Method A (short time)
2.	Method B (step by step)

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